



## SY88216L

### 3.3V, 2.5Gbps Burst Mode Laser Driver

#### General Description

The SY88216L is a single supply 3.3V burst mode laser driver for A-PON, B-PON, EPON, GE-PON, and G-PON applications with data rates from 155Mbps up to 2.5Gbps. The driver can deliver modulation current up to 85mA, and provides a high compliance voltage that makes it suitable for high-current operation with the laser DC-coupled to it.

All support documentation can be found on Micrel's web site at: [www.micrel.com](http://www.micrel.com).

#### Features

- 2.4V minimum laser compliance voltage
- Operation up to 2.5Gbps
- Fast burst mode enable/disable delay
- Modulation current up to 85mA
- Bias current up to 70mA
- Infinite bias current hold time between bursts
- Safety features
- Power monitoring
- Available in 24-pin (4mm x 4mm) QFN package

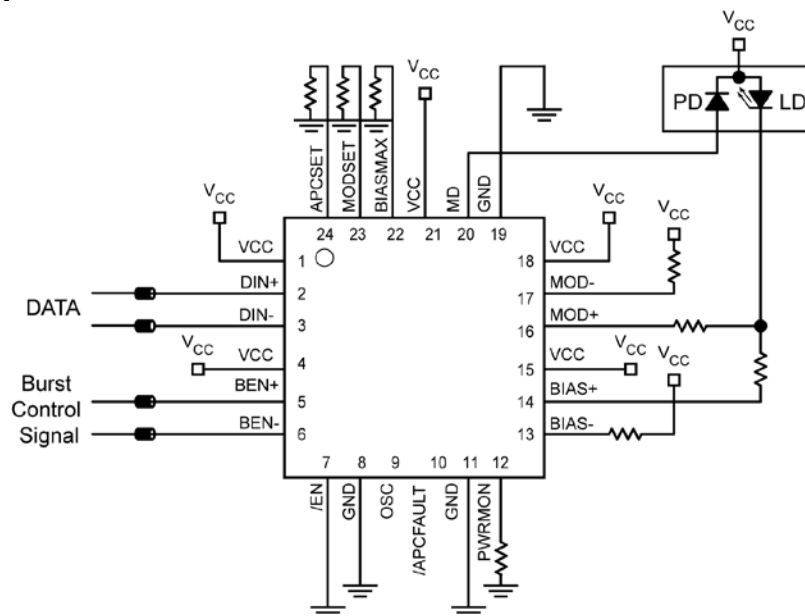
#### Applications

- Multi-rate burst mode applications: A-PON, B-PON, G-PON, E-PON, GE-PON

#### Markets

- Fiber-to-the-Premises (FTTP): Fiber-to-the-Home (FTTH), Fiber-to-the-Business (FTTB)
- FTTC (Fiber-to-the-Curb)

#### Typical Application



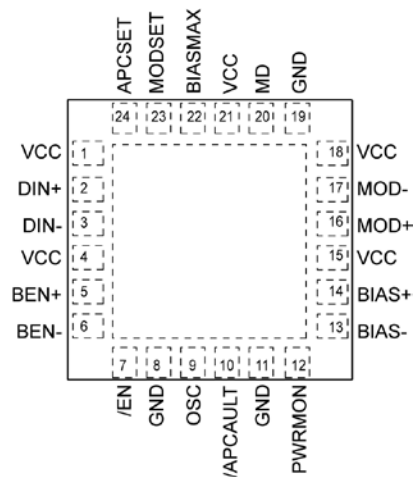
## Ordering Information<sup>(1)</sup>

| Part Number                 | Package Type | Operating Range | Package Marking                      | Lead Finish    |
|-----------------------------|--------------|-----------------|--------------------------------------|----------------|
| SY88216LMG                  | QFN-24       | Industrial      | 216L with Pb-Free bar-line indicator | NiPdAu Pb-Free |
| SY88216LMGTR <sup>(2)</sup> | QFN-24       | Industrial      | 216L with Pb-Free bar-line indicator | NiPdAu Pb-Free |

### Notes:

1. Contact factory for die availability. Dice are guaranteed at  $T_A = +25^{\circ}\text{C}$ , DC Electrical only.
2. Tape and Reel.

## Pin Configuration



24-Pin QFN

## Pin Description

| Pin Number       | Pin Name  | Pin Function                                                                                                                                                                                                                                                                                                                                                                |
|------------------|-----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2                | DIN+      | Non-inverting input data. Internally terminated with 50Ω to a reference voltage.                                                                                                                                                                                                                                                                                            |
| 3                | DIN-      | Inverting input data. Internally terminated with 50Ω to a reference voltage.                                                                                                                                                                                                                                                                                                |
| 5                | BEN+      | Non-inverting burst enable. Accepts any input, single-ended or differential: TTL/CMOS, LVPECL, CML, LVDS, HSTL, and SSTL. BEN requires an external termination. See Figure 2.                                                                                                                                                                                               |
| 6                | BEN-      | Inverting burst enable. Accepts any input, single-ended or differential: TTL/CMOS, LVPECL, CML, LVDS, HSTL, and SSTL. BEN requires an external termination. See Figure 2.                                                                                                                                                                                                   |
| 7                | /EN       | Active low TTL/CMOS. Internally pulled-up. Pull-down with a 22kΩ or lower resistance or apply a low level signal (<0.8 V) to enable bias and modulation. Keep floating or apply a high level (>2 V) to disable.                                                                                                                                                             |
| 9                | OSC       | Internal oscillator setting option. Install a 0Ω resistor from this pin to VCC or leave it open to set the frequency. Refer to the frequency table.                                                                                                                                                                                                                         |
| 10               | /APCFAULT | Indicates APC failure when low. Active low TTL/CMOS.                                                                                                                                                                                                                                                                                                                        |
| 12               | PWRMON    | Power Monitor. Provides a current which is proportional to the sum of bias current and half of modulation current. Install a resistor between this pin and GND to convert that current to a voltage.                                                                                                                                                                        |
| 13               | BIAS-     | Inverting laser bias current output. Pull-up to VCC with a resistor.                                                                                                                                                                                                                                                                                                        |
| 14               | BIAS+     | Non-inverting laser bias current output, sources current when BEN is high. Connect to the cathode of the laser through a resistor.                                                                                                                                                                                                                                          |
| 16               | MOD+      | Non-inverted modulation current output. Provides modulation current when input data is positive.                                                                                                                                                                                                                                                                            |
| 17               | MOD-      | Inverted modulation current output. Provides modulation current when input data is negative.                                                                                                                                                                                                                                                                                |
| 20               | MD        | Input from the laser monitoring photodiode. Connect to the anode of the photodiode for APC operation.                                                                                                                                                                                                                                                                       |
| 22               | BIASMAX   | Install a resistor between this pin and GND to set the maximum bias current for the closed loop operation. The APC loop controls the bias current up to the level of BIASMAX. When the bias current reaches the maximum value set through this pin, the driver continues to sink a current equal to this maximum. For open loop operations, this pin sets the bias current. |
| 23               | MODSET    | Modulation current setting and control. The modulation current is set by installing an external resistor from this pin-to-ground or using a current source.                                                                                                                                                                                                                 |
| 24               | APCSET    | Bias current setting and control. The bias current is set by installing an external resistor from this pin to ground or using a current source. Connect a 50K resistor-to-GND for open loop operation.                                                                                                                                                                      |
| 8, 11, 19        | GND       | Ground. Ground and exposed pad must be connected to the plane of the most negative potential.                                                                                                                                                                                                                                                                               |
| 1, 4, 15, 18, 21 | VCC       | Supply Voltage. Bypass with a 0.1μF//0.01μF low ESR capacitor as close to VCC pin as possible.                                                                                                                                                                                                                                                                              |

## Truth Table

| DIN+ | DIN- | /EN | MOD+ <sup>(1)</sup> | MOD- | Laser Output <sup>(2)</sup> |
|------|------|-----|---------------------|------|-----------------------------|
| L    | H    | L   | H                   | L    | L                           |
| H    | L    | L   | L                   | H    | H                           |
| X    | X    | H   | H                   | L    | L                           |

### Notes:

- $I_{MOD} = 0$  when MOD+ = H.
- Assuming that the laser is tied to MOD+.

## Oscillator Frequency

| OSC  | Frequency (MHz) |
|------|-----------------|
| Open | 25              |
| VCC  | 50              |

**Absolute Maximum Ratings<sup>(1)</sup>**

Supply Voltage ( $V_{CC}$ ) ..... -0.5V to +4.0V  
 CML Input Voltage ( $V_{IN}$ ) .....  $V_{CC}-1.2V$  to  $V_{CC}+0.5V$   
 TTL Control Input Voltage ( $V_I$ ) ..... 0V to  $V_{CC}+0.3V$   
 Lead Temperature (soldering, 20sec.) ..... +260°C  
 Storage Temperature ( $T_s$ ) ..... -65°C to +150°C

**Operating Ratings<sup>(2)</sup>**

Supply Voltage ( $V_{CC}$ ) ..... +3.0V to +3.6V  
 Ambient Temperature ( $T_A$ ) ..... -40°C to +85°C  
 Package Thermal Resistance<sup>(3)</sup>  
     QFN  
     ( $\theta_{JA}$ ) Still-air ..... 75°C/W  
     ( $\psi_{JB}$ ) ..... 30°C/W

**DC Electrical Characteristics**

$T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$  and  $V_{CC} = +3.0V$  to  $+3.6V$ . Unless otherwise noted, typical values are  $V_{CC} = +3.3V$ ,  
 $T_A = 25^\circ\text{C}$ ,  $I_{MOD} = 25\text{mA}$ ,  $I_{BIAS} = 20\text{mA}$ .

| Symbol              | Parameter                                                                            | Condition                                          | Min  | Typ | Max               | Units            |
|---------------------|--------------------------------------------------------------------------------------|----------------------------------------------------|------|-----|-------------------|------------------|
| $I_{CC}$            | Power Supply Current                                                                 | Modulation and Bias currents excluded              |      | 55  | 95 <sup>(4)</sup> | mA               |
| $V_{MOD\_MIN}$      | Minimum Voltage Required at the Driver Output, MOD+ and MOD-, for Proper Operation   |                                                    | 0.6  |     |                   | V                |
| $V_{BIAS\_MIN}$     | Minimum Voltage Required at the Driver Output, BIAS+ and BIAS-, for Proper Operation |                                                    | 0.8  |     |                   | V                |
| $I_{BIAS}$          | Bias-ON Current                                                                      | Voltage at Bias pin $\geq 0.8V$                    | 1    |     | 70                | mA               |
| $I_{BIAS\_OFF}$     | Bias-OFF Current                                                                     | Current at BIAS pin when /EN is high or BEN is low |      |     | 150               | $\mu\text{A}$    |
| $R_{IN}$            | Input Resistance at DIN+ and DIN-                                                    | Single ended                                       | 42.5 | 50  | 57.5              | $\Omega$         |
| $V_{DIFF-IN} (DIN)$ | Differential Input Voltage Swing                                                     |                                                    | 100  |     | 2400              | mV <sub>PP</sub> |
| $V_{IL} (/EN)$      | /EN Input Low                                                                        |                                                    |      |     | 0.8               | V                |
| $V_{IH} (/EN)$      | /EN Input High                                                                       |                                                    | 2    |     |                   | V                |
| $V_{OL}$            | /APCFAULT Output Low                                                                 | $I_{OL} = 2\text{mA}$                              |      |     | 0.5               | V                |
| $I_{OH}$            | /APCFAULT Output Leakage                                                             | $V_{OH} = V_{CC}$                                  |      |     | 100               | $\mu\text{A}$    |
| BEN+, BEN-          | Burst Mode Enable Signal                                                             | Single Ended                                       |      | 0.8 |                   | V                |
| $V_{IH} (BEN)$      | High Voltage                                                                         | BEN+, BEN-                                         |      |     | $V_{CC} + 0.3$    | V                |
| $V_{IL} (BEN)$      | Low Voltage                                                                          | BEN+, BEN-                                         | -0.3 |     |                   | V                |
| $V_{IN} (BEN)$      | Input Voltage Swing                                                                  | BEN+, BEN-                                         | 100  |     |                   | mV               |
| $V_{DIFF-IN} (BEN)$ | Differential Input Voltage Swing                                                     | BEN+, BEN-                                         | 200  |     |                   | mV <sub>PP</sub> |
| $V_{PWRMON}$        | Maximum Voltage at PWRMON Pin                                                        |                                                    | 1.25 |     |                   | V                |
| $I_{MD}$            | Current Range at MD Pin                                                              |                                                    | 50   |     | 1500              | $\mu\text{A}$    |

**Notes:**

1. Permanent device damage may occur if absolute maximum ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
3. Package Thermal Resistance assumes exposed pad is soldered (or equivalent) to the devices most negative potential on the PCB.  $\psi_{JB}$  uses a 4-layer and  $\theta_{JA}$  in still air unless otherwise stated.
4.  $I_{CC} = 95\text{mA}$  for worst-case conditions with  $I_{MOD} = 85\text{mA}$ ,  $I_{BIAS} = 70\text{mA}$ ,  $T_A = +85^\circ\text{C}$ ,  $V_{CC} = 3.6$ .

## AC Electrical Characteristics

$T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and  $V_{CC} = +3.0\text{V}$  to  $+3.6\text{V}$ . Unless otherwise noted, typical values are  $V_{CC} = +3.3\text{V}$ ,

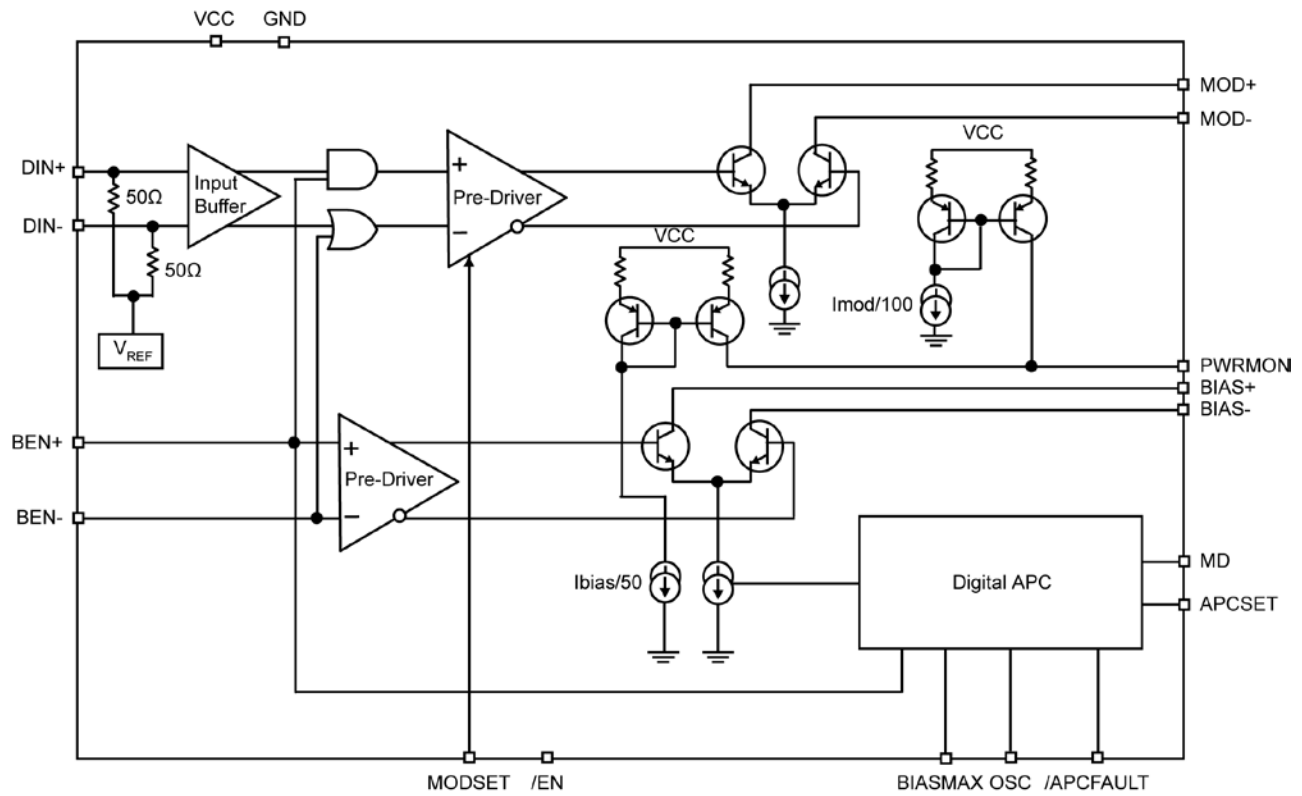
$T_A = 25^{\circ}\text{C}$ ,  $I_{MOD} = 25\text{mA}$ ,  $I_{BIAS} = 20\text{mA}$ .

| Symbol         | Parameter                              | Condition                                               | Min   | Typ | Max               | Units            |
|----------------|----------------------------------------|---------------------------------------------------------|-------|-----|-------------------|------------------|
|                | Data Rate                              | NRZ                                                     | 0.155 |     | 2.5               | Gbps             |
| $I_{MOD}$      | Modulation Current <sup>(5)</sup>      | AC-coupled                                              | 10    |     | 85                | mA               |
|                |                                        | DC-coupled, Voltage at MOD Pin $\geq 0.6\text{V}$       | 10    |     | 70 <sup>(6)</sup> | mA               |
| $I_{MOD\_OFF}$ | Modulation OFF Current                 | Current at MOD+ when /EN is High or BEN is High         |       |     | 150               | $\mu\text{A}$    |
|                |                                        | Current at MOD- when /EN is High or BEN is Low          |       |     | 150               | $\mu\text{A}$    |
| $t_r$          | Output Current Rise Time               | 20% to 80%, $I_{MOD} = 60\text{mA}$                     |       | 60  | 85                | ps               |
| $t_f$          | Output Current Fall Time               | 20% to 80%, $I_{MOD} = 60\text{mA}$                     |       | 60  | 85                | ps               |
| Jitter         | Total Jitter <sup>(7)</sup>            | 155Mbps                                                 |       |     | 30                | pS <sub>Pp</sub> |
|                |                                        | 622Mbps                                                 |       |     | 30                |                  |
|                |                                        | 1.25Gbps                                                |       |     | 30                |                  |
|                |                                        | 2.5Gbps                                                 |       |     | 30                |                  |
| $t_{INIT}$     | APC Loop Initialization Time           | Power up with /En Low and BEN High                      |       |     | 12                | $\mu\text{s}$    |
|                |                                        | /EN Changes from High to Low with Power ON and BEN High |       |     | 10                | $\mu\text{s}$    |
|                |                                        | BEN Changes from Low to High with Power ON and /EN Low  |       |     | 2.5               | ns               |
|                | Burst Enable Delay <sup>(8, 9)</sup>   |                                                         |       |     | 2.5               | ns               |
|                | Burst Disable Delay <sup>(8, 10)</sup> |                                                         |       |     | 2                 | ns               |
|                | Burst ON-Time                          | 155Mbps                                                 | 1.9   |     |                   | $\mu\text{s}$    |
|                |                                        | 622Mbps                                                 | 720   |     |                   | ns               |
|                |                                        | 1.25Gbps                                                | 576   |     |                   | ns               |
|                |                                        | 2.5Gbps                                                 | 576   |     |                   | ns               |
|                | Burst OFF-Time                         | 155Mbps                                                 | 1.9   |     |                   | $\mu\text{s}$    |
|                |                                        | 622Mbps                                                 | 720   |     |                   | ns               |
|                |                                        | 1.25Gbps                                                | 576   |     |                   | ns               |
|                |                                        | 2.5Gbps                                                 | 576   |     |                   | ns               |

### Notes:

- Load =  $15\Omega$ .
- Assuming  $V_{CC} = 3.0\text{V}$ , Laser bandgap voltage =  $1\text{V}$ , laser package inductance =  $1\text{nH}$ , laser equivalent series resistor =  $5\Omega$ , and damping resistor =  $10\Omega$ .
- Total jitter is measured using  $2^7 - 1$  PRBS pattern.
- Measured with a laser equivalent resistive load.
- Burst Enable Delay is measured as the time between the instant when the BEN+ signal going from low to high reaches 50% of its amplitude and the instant at which the modulation current or the bias current (whichever takes longer) reaches 90% of its final value.
- Burst Disable Delay is measured as the time between the instant when the BEN+ signal going from high to low reaches 50% of its amplitude and the instant at which the modulation current or the bias current (whichever takes longer) goes below 10% of its final value.

## Functional Diagram



## Detailed Functional Description

The SY88216L burst mode laser driver is comprised from a fast modulator, a fast bias circuit, and a digital APC loop that allows for fast laser turn-ON time. The modulator is comparable to a fast continuous mode modulator that turns ON in the nanosecond range. The bias circuit has a differential pair at the output to allow for fast turn-ON time. Both modulator and bias differential pairs can be enabled for burst operation by applying a high level signal at BEN+ pin and a low level signal at BEN- pin.

The driver features a power monitoring function.

### BIAS and Modulation Setting

Bias and modulation currents are set by installing resistors from APCSET (pin24)-to-ground and from MODSET (pin23)-to-ground respectively or by applying a negative current at those pins.  $I_{BIAS}$  variation versus  $R_{APCSET}$  resistor,  $I_{BIAS}$  variation versus  $R_{BIASMAX}$  resistor, and  $I_{MOD}$  variation versus  $R_{MODSET}$  resistor are shown on Page 8.

### BIASMAX

A resistor between the BIASMAX pin and ground sets the maximum bias the driver can sink. At normal operation, the bias current tracks the laser optical power through the laser monitoring photodiode and the APC loop to compensate for any power deviation from the nominal value set at the start of operation using APCSET. If any failure occurs (laser or photodiode degradation, open feedback circuit etc.) the APC loop keeps increasing the bias current in an effort to compensate for the low power indication, the bias current will then stop increasing when it reaches BIASMAX value and continue to operate at that maximum value and APCFAULT asserted.

BIASMAX also controls the bias current when the circuit is operating in the open loop mode.

### APC Loop Function

At start up, with the driver enabled and burst mode enabled, the laser turns ON within a few microseconds and its back facet monitoring photodiode starts to generate a photocurrent proportional to the optical power. The photocurrent is fed back to the MD pin on the driver where it's converted to a voltage. The conversion voltage is compared to APCSET on the driver. At equilibrium, the feedback voltage equals the APCSET voltage and the laser optical power reaches its nominal value. If the laser power deviates from its nominal value, the APC loop brings it back to its nominal setting. After everything is settled to its nominal value and the BEN changes from high to low to disable the burst mode, the instantaneous bias current value is latched until BEN switches from low to high again. Then the bias and modulation output stages turn ON and the bias stays equal to the stored value until the feedback from the monitoring photodiode reaches the APCSET value and the APC closed loop starts to regulate the laser power.

### APC Loop Failure

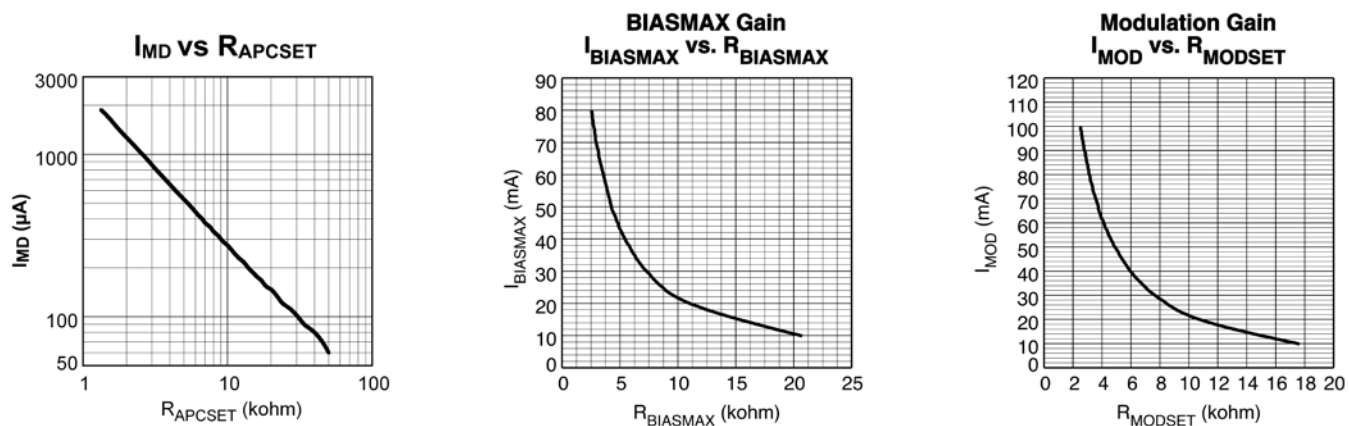
The APCFAULT is asserted Low if the bias current reaches BIASMAX or if the APC loop counter reaches its minimum or its maximum counts.

### Interfacing the Driver with the Laser Diode

As shown on the "Typical Application" drawing, MOD+ pin is connected to the laser cathode through a  $10\Omega$  resistor and MOD- pin is connected to VCC with a  $15\Omega$  resistor equivalent to  $10\Omega$  (damping resistor) in series with the laser (equivalent resistor of  $5\Omega$ ). The laser can be driven differentially by connecting MOD- to the anode of the laser through  $15\Omega$  ( $15\Omega$  pull-up removed) and isolating the anode of the laser from VCC with an inductor.

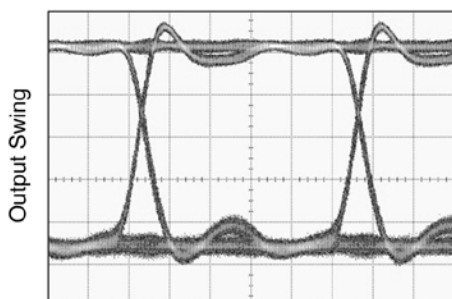
To meet the stringent laser turn-ON time, per BPON/GPON/EPON spec, the bias (BIAS+ pin) must be connected to the cathode of the laser through a resistor not an inductor as in continuous mode. BIAS- pin is pulled-up to VCC.

## Typical Characteristics



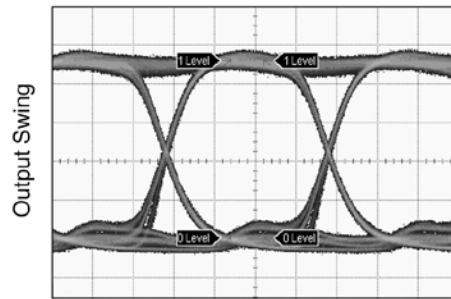
## Functional Characteristics

**Electrical Eye Diagram  
@1.25Gbps**



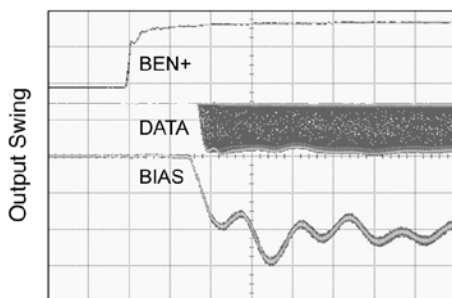
TIME (150ps/div.)

**Optical Eye Diagram  
@1.25Gbps with 2.3G Filter**



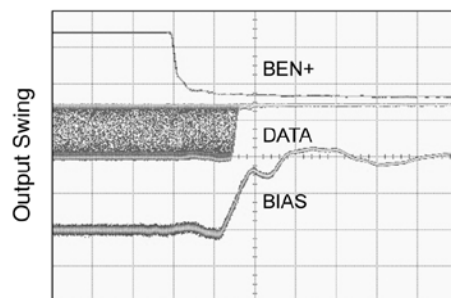
TIME (200ps/div.)

**Modulation and Bias Turn-On**



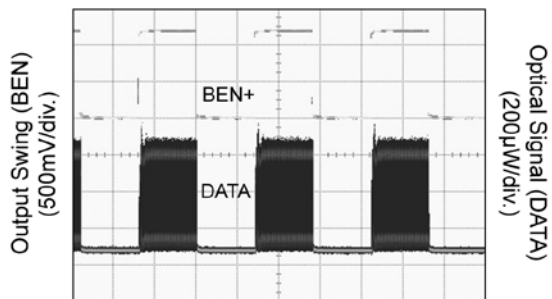
TIME (1ns/div.)

**Modulation and Bias Turn-Off**



TIME (1ns/div.)

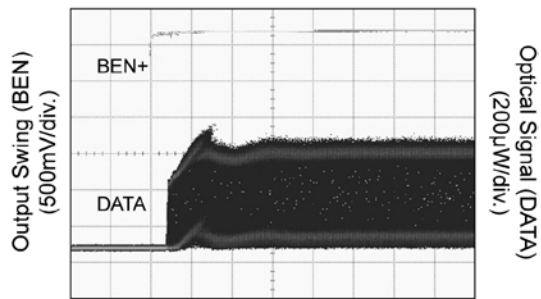
**Burst Mode Operation with a Laser**



TIME (300ns/div.)

Optical Signal (DATA)  
(200μW/div.)

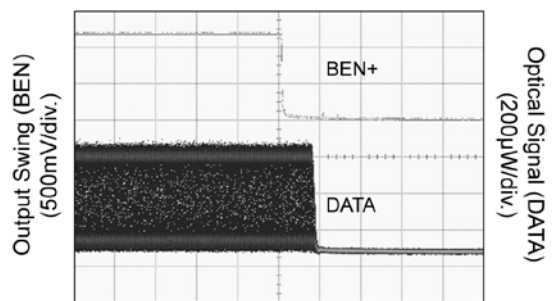
**Laser Turn-On**



TIME (20ns/div.)

Optical Signal (DATA)  
(200μW/div.)

**Laser Turn-Off**



TIME (10ns/div.)

Optical Signal (DATA)  
(200μW/div.)

## Input and Output Stages

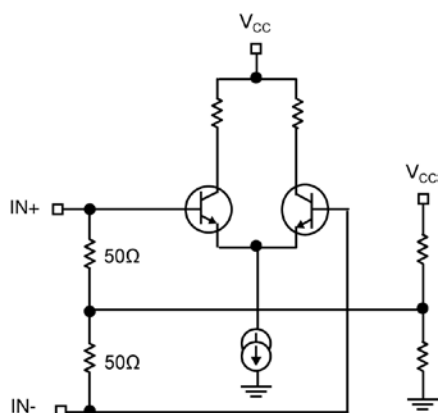


Figure 1a. Simplified Input Stage

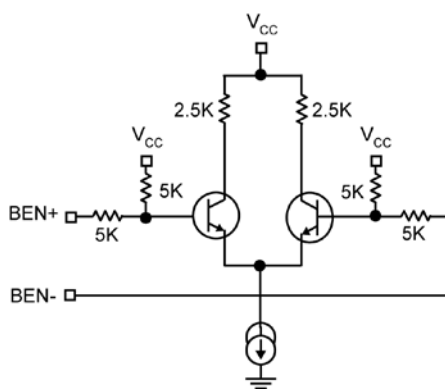


Figure 1b. Simplified BEN Input Stage

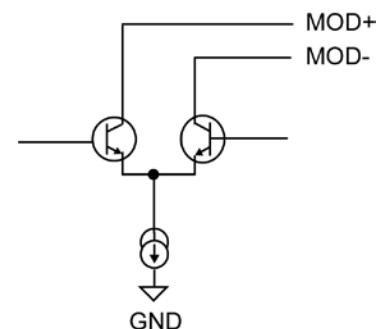


Figure 1c. Simplified Output Stage

## Interfacing DIN and BEN Inputs to Different Logic Drivers

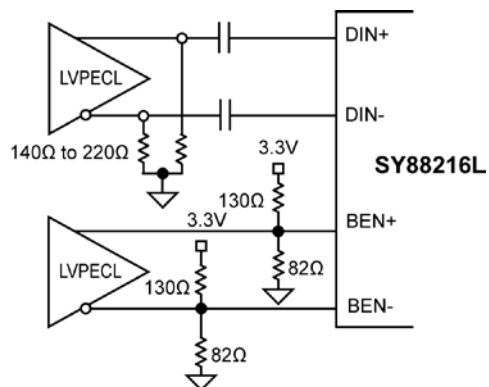


Figure 2a. Driving DIN and BEN with PECL Outputs

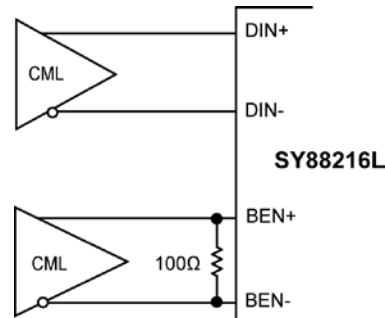


Figure 2b. Driving DIN and BEN with CML Outputs

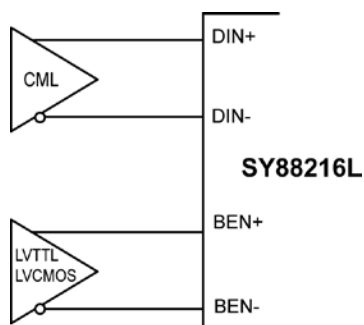


Figure 2c. Driving BEN with LVTTTL/LCMOS Outputs

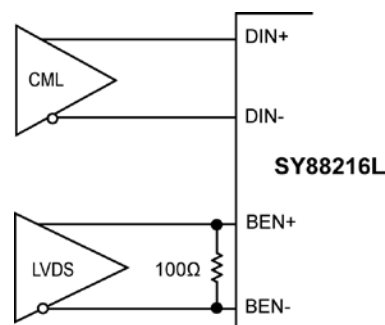
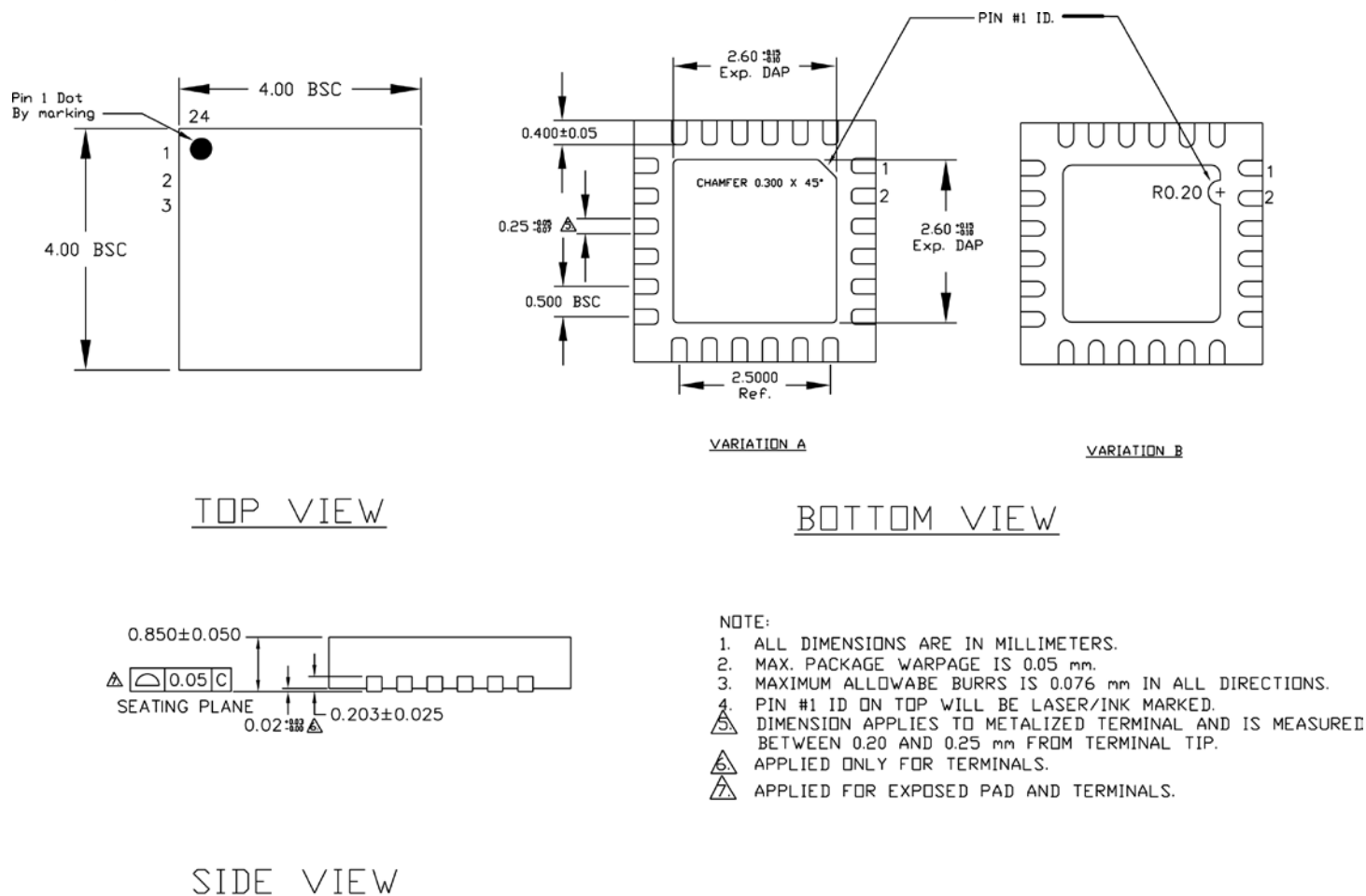


Figure 2d. Driving BEN with LVDS Outputs

## Package Information



**24-Pin (3mm x 3mm) QFN**

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